

20A, 100V Trench Schottky Rectifier

FEATURES

- Excellent high temperature stability
- Low forward voltage
- Low power loss/ High efficiency
- High forward surge capability
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

• Case: TO-220AB

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

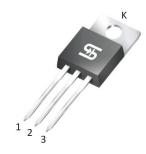
Mounting torque: 0.56 N·m maximum
Meet JESD 201 class 2 whisker test

Polarity: As marked

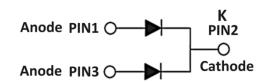
• Weight: 1.97g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
l _F	20	Α	
V_{RRM}	100	V	
I _{FSM}	215	Α	
T _{J MAX}	150	°C	
Package	TO-220AB		
Configuration	Common cathode		





TO-220AB



PARAMETER		SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		V _{RRM}	100	V
Reverse voltage, total rms value		V _R (RMS)	70	V
Forward current	per device		20	А
	per diode	l _F	10	А
Surge peak forward current, 8.3ms si wave superimposed on rated load	ngle half sine	I _{FSM}	215	А
Junction temperature		TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C



Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance per diode(1)	R _{OJL}	1.3	°C/W
Junction-to-ambient thermal resistance per diode(1)	Reja	5.4	°C/W
Junction-to-case thermal resistance per diode(2)	Reлc	0.9	°C/W

Thermal Performance Notes:

- 1. Units mounted on 4" x 6" x 0.25" Al-plate
- 2. Mounted on infinite heatsink

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 5A, T _J = 25°C	VF	0.65	-	V
	I _F = 10A, T _J = 25°C		0.78	0.82	V
	I _F = 5A, T _J = 125°C		0.56	-	V
	I _F = 10A, T _J = 125°C		0.66	0.69	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C	I _R	-	50	μΑ
	T _J = 125°C		-	10	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TST20102C	TO-220AB	50 / Tube	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

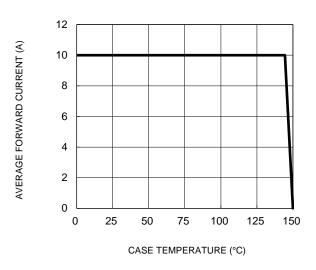


Fig.3 Typical Reverse Characteristics

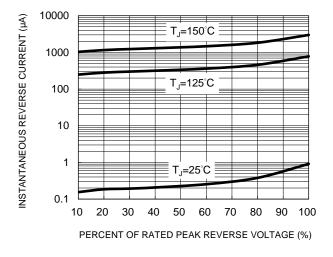
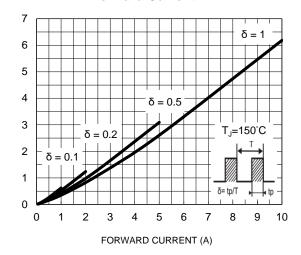


Fig.5 Typical Forward Power Dissipation vs. Forward Current



POWER DISSIPATION (W)

Fig.2 Typical Junction Capacitance

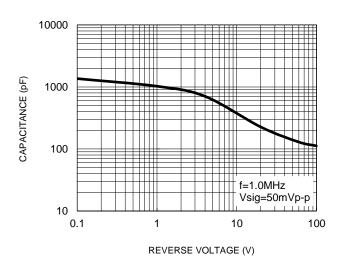
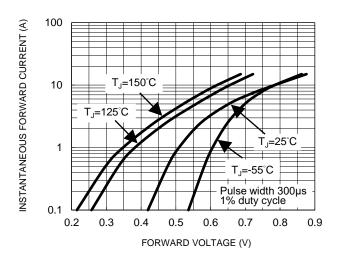


Fig.4 Typical Forward Characteristics

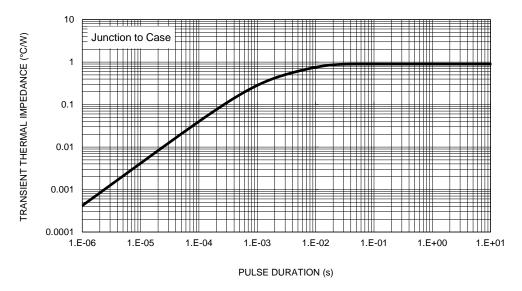




CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

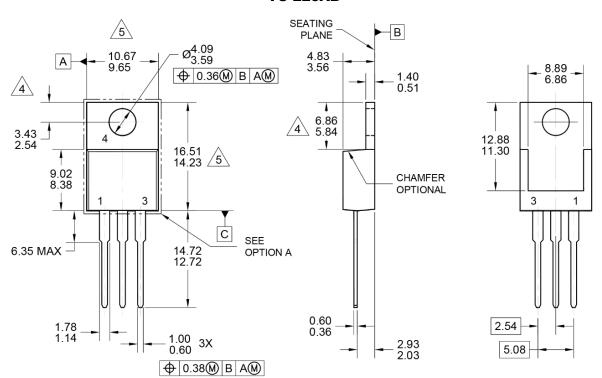
Fig.6 Typical Transient Thermal Characteristics

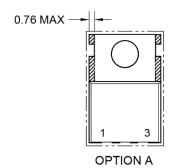


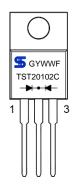


PACKAGE OUTLINE DIMENSIONS

TO-220AB







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-220, VARIATION AB, ISSUE K.
- THE DEFINED ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. SLOT AND NOTCH MAY APPEAR IN THIS ZONE.
- THIS DO NOT INCLUDE MOLD FLASH.
 THESE DIMENSIONS ARE MEASURED AT
 THE OUTERMOST EXTREME OF THE
 PLASTIC BODY.
 - 6. DWG NO REF: HQ2SD07-TO220AB-011 REV A.

MARKING DIAGRAM

G = Green compound

YWW = Date code F = Factory code



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.